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Renesas Technology Corp.
Customer Support Dept.
April 1, 2003

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Keep safety first in your circuit designs!

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Remember to give due consideration to safety when making your circuit designs, with appropriate measures such as (i) placement of substitutive, auxiliary circuits, (ii) use of nonflammable material or (iii) prevention against any malfunction or mishap.

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HD74LVC32

Quad. 2-input OR Gates

RENESAS

ADE-205-065B(Z)

Rev.2
September 1995

Description

The HD74LVC32 has four 2-input OR gates in a 14 pin package. Low voltage and high speed operation is suitable at the battery drive product (note type personal computer) and low power consumption extends the life of a battery for long time operation.

Features

- $V_{CC} = 2.0\text{ V to }5.5\text{ V}$
- All inputs $V_{IH}(\text{Max.}) = 5.5\text{ V} (@V_{CC} = 0\text{ V to }5.5\text{ V})$
- Typical V_{OL} ground bounce $< 0.8\text{ V} (@V_{CC} = 3.3\text{ V}, T_a = 25^\circ\text{C})$
- Typical V_{OH} undershoot $> 2.0\text{ V} (@V_{CC} = 3.3\text{ V}, T_a = 25^\circ\text{C})$
- High output current $\pm 24\text{ mA} (@V_{CC} = 3.0\text{ V to }5.5\text{ V})$

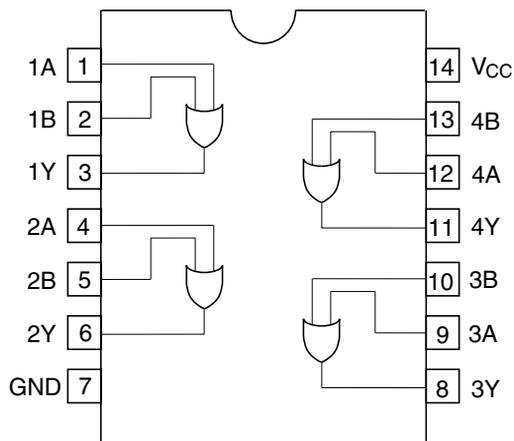
Function Table

Inputs		Output Y
A	B	
L	L	L
H	L	H
L	H	H
H	H	H

H : High level

L : Low level

Pin Arrangement



(Top view)

Absolute Maximum Ratings

Item	Symbol	Ratings	Unit	Conditions
Supply voltage range	V_{CC}	-0.5 to 6.0	V	
Input diode current	I_{IK}	-50	mA	$V_I = -0.5$ V
Input voltage	V_I	-0.5 to 6.0	V	
Output diode current	I_{OK}	-50	mA	$V_O = -0.5$ V
		50	mA	$V_O = V_{CC} + 0.5$ V
Output voltage	V_O	-0.5 to $V_{CC} + 0.5$	V	
Output current	I_O	±50	mA	
V_{CC} , GND current / pin	I_{CC} or I_{GND}	100	mA	
Storage temperature	T _{stg}	-65 to +150	°C	

Note: The absolute maximum ratings are values which must not individually be exceeded, and furthermore, no two of which may be realized at the same time.

Recommended Operating Conditions

Item	Symbol	Ratings	Unit	Conditions
Supply voltage	V_{CC}	1.5 to 5.5	V	Data retention
		2.0 to 5.5	V	At operation
Input / Output voltage	V_I	0 to 5.5	V	A, B
	V_O	0 to V_{CC}	V	Y
Operating temperature	T_a	-40 to 85	°C	
Output current	I_{OH}	-12	mA	$V_{CC} = 2.7\text{ V}$
		-24 ²	mA	$V_{CC} = 3.0\text{ V to }5.5\text{ V}$
	I_{OL}	12	mA	$V_{CC} = 2.7\text{ V}$
		24 ²	mA	$V_{CC} = 3.0\text{ V to }5.5\text{ V}$
Input rise / fall time ¹	t_r, t_f	10	ns/V	

Notes: 1. This item guarantees maximum limit when one input switches.

Waveform : Refer to test circuit of switching characteristics.

2. duty cycle ≤ 50%

Electrical Characteristics

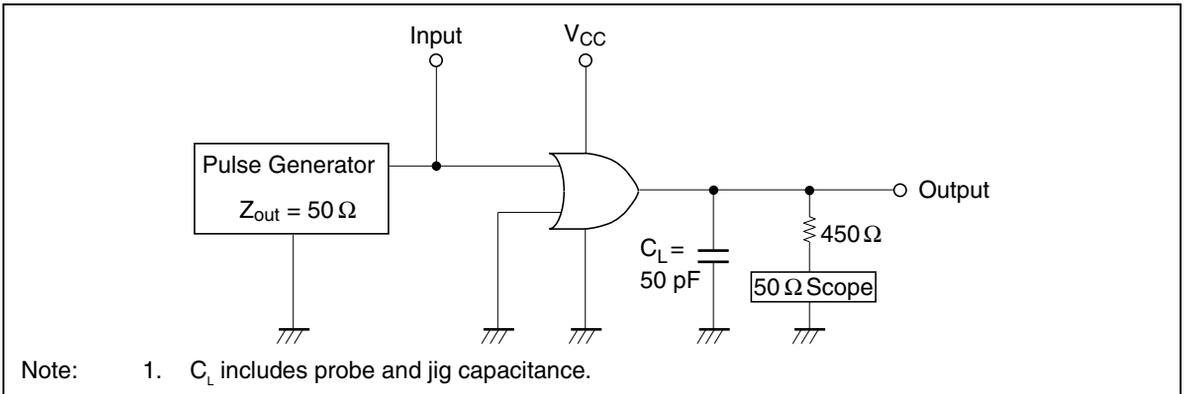
$T_a = -40\text{ to }85^\circ\text{C}$

Item	Symbol	V_{CC} (V)	$T_a = -40\text{ to }85^\circ\text{C}$		Unit	Test Conditions
			Min	Max		
Input voltage	V_{IH}	2.7 to 3.6	2.0	—	V	
		4.5 to 5.5	$V_{CC} \times 0.7$	—	V	
	V_{IL}	2.7 to 3.6	—	0.8	V	
		4.5 to 5.5	—	$V_{CC} \times 0.3$	V	
Output voltage	V_{OH}	2.7 to 5.5	$V_{CC} - 0.2$	—	V	$I_{OH} = -100\ \mu\text{A}$
		2.7	2.2	—	V	$I_{OH} = -12\ \text{mA}$
		3.0	2.4	—	V	$I_{OH} = -12\ \text{mA}$
		3.0	2.0	—	V	$I_{OH} = -24\ \text{mA}$
		4.5	3.8	—	V	$I_{OH} = -24\ \text{mA}$
	V_{OL}	2.7 to 5.5	—	0.2	V	$I_{OL} = 100\ \mu\text{A}$
		2.7	—	0.4	V	$I_{OL} = 12\ \text{mA}$
		3.0	—	0.55	V	$I_{OL} = 24\ \text{mA}$
		4.5	—	0.55	V	$I_{OL} = 24\ \text{mA}$
Input current	I_{IN}	0 to 5.5	—	±5.0	μA	$V_{IN} = 5.5\text{ V or GND}$
Quiescent supply current	I_{CC}	5.5	—	20	μA	$V_{IN} = V_{CC}$ or GND
	ΔI_{CC}	3.0 to 3.6	—	500	μA	$V_{IN} =$ one input at $(V_{CC} - 0.6)\text{V}$, other inputs at V_{CC} or GND

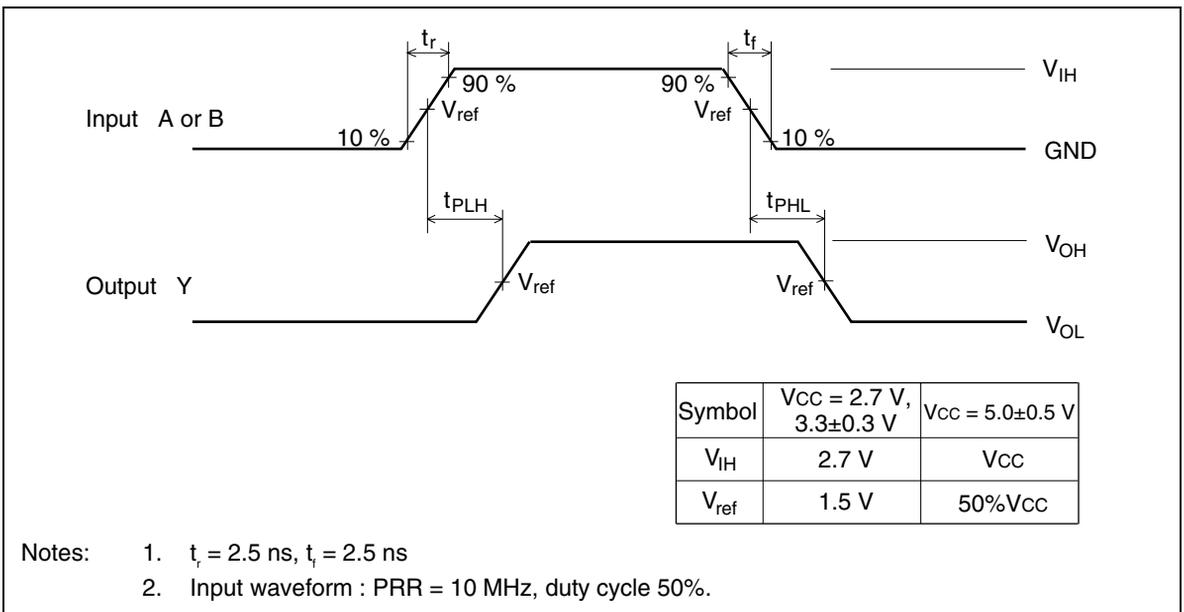
Switching Characteristics**Ta = -40 to 85°C**

Item	Symbol	V _{CC} (V)	Ta = -40 to 85°C			Unit	From (Input)	To (Output)
			Min	Typ	Max			
Propagation delay time	t _{PLH}	2.7	—	4.5	7.0	ns	A or B	Y
	t _{PHL}	3.3±0.3	1.5	3.5	6.0	ns		
		5.0±0.5	—	3.0	5.0	ns		
Input capacitance	C _{IN}	2.7	—	3.0	—	pF		
Output capacitance	C _O	2.7	—	15.0	—	pF		

Test Circuit



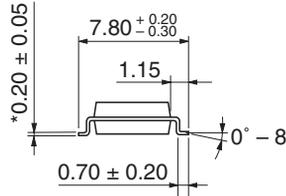
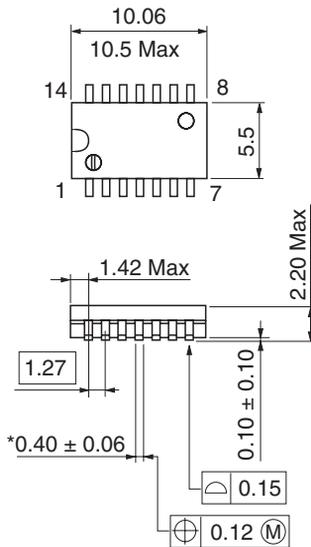
Waveforms



Package Dimensions

As of July, 2001

Unit: mm

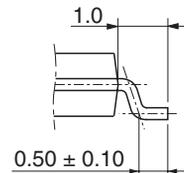
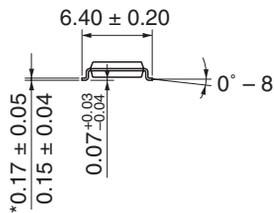
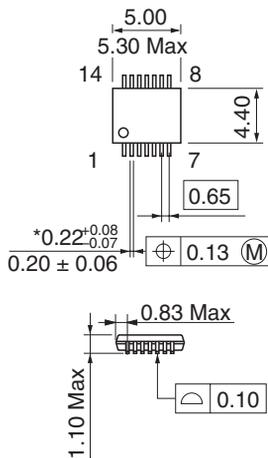


*Pd plating

Hitachi Code	FP-14DAV
JEDEC	—
JEITA	Conforms
Mass (reference value)	0.23 g

As of July, 2001

Unit: mm



*Dimension including the plating thickness
Base material dimension

Hitachi Code	TTP-14D
JEDEC	—
JEITA	—
Mass (reference value)	0.05 g

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